General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

FEATURES

- · Low assembly costs
- High component and equipment reliability
- Excellent performance at high frequency, especially the RC31
- · Complete standard SMD family.

APPLICATIONS

• All general purpose applications.

DESCRIPTION

The resistors are constructed on a high grade ceramic body (aluminium oxide). Internal metal electrodes are added at each end and connected by a resistive paste which is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance, by laser cutting of this resistive layer.

The resistive layer is covered with a protective coat and printed with the resistance value. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a lead/tin alloy.

QUICK REFERENCE DATA

DESCRIPTION	VALUE						
DESCRIPTION	RC01	RC11	RC21	RC31			
Size code	1206 (3216)	0805 (2012)	0603 (1608)	0402(1005)			
Resistance range		1 Ω to 10 M Ω 6.8 Ω to 2.2 Ms					
Resistance tolerance and E-series		±5%	, ±2%; E24 serie	es			
Temperature coefficient:							
1 Ω ≤ R < 10 Ω	≤250 ±250 × 10 ⁻⁶ /K						
$10 \Omega < R \le 10 M\Omega$	$\leq \pm 200 \times 10^{-6} / K$						
Maximum dissipation at T _{amb} = 70 °C	0.25 W	0.125 W	0.063 W	0.063 W			
Maximum permissible voltage	200 V (DC or RMS)	150 V (DC or RMS)	50 V (DC or RMS)	50 V (DC or RMS)			
Climatic category (IEC 60068)	55/155/56 55/125/56						
Basic specification	IEC 60115-8						

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

ORDERING INFORMATION

Table 1 Ordering code indicating resistor type and packaging

				ORDERING CO	DE 2322		
TYPE	TOL.		PAPER TAPE	BULK CASE			
2	(%)	5000 units	10000 units	20000 units	50000 units	10000 units	25000 units
RC01	±5	711 61	711 51	711 81	_	_	_
RCUI	±2	711 41	_	711 71	_	_	_
RC11	±5	730 61	730 71	730 81	_	731 81	_
KCII	±2	730 31	_	730 41	_	731 51	_
RC21	±5	702 60	702 70	702 81	_	_	702 80
RC21	±2	702 65	_	702 75	_	_	702 50
RC31	±5	_	705 70	_	705 87	_	_
KC31	±2	_	705 75	_	_	_	702 50
Jumper 0 9	2						
RC01 ⁽¹⁾	_	711 91032	711 91005	711 92004	_	_	_
RC11 ⁽¹⁾	_	730 91002	730 91003	730 92002	_	731 91006	_
RC21 ⁽²⁾	_	702 96001	702 97001	702 92002	_	_	702 91002
RC31 ⁽²⁾	_		705 91001		705 91007		

Notes

- 1. The jumper has a maximum resistance $R_{max} = 50 \text{ m}\Omega$ and a rated current $I_R = 2 \text{ A}$.
- 2. The jumper has a maximum resistance $R_{max} = 50 \text{ m}\Omega$ and a rated current $I_R = 1 \text{ A}$.

Ordering code (12NC)

- The resistors have a 12-digit ordering code starting with 2322
- The subsequent 5 digits indicate the resistor type and packaging; see Table 1.
- The remaining 3 digits indicate the resistance value:
 - The first 2 digits indicate the resistance value.
 - The last digit indicates the resistance decade in accordance with Table 2.

Table 2 Last digit of 12NC

RESISTANCE DECADE	LAST DIGIT
1 to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
1 to 9.76 kΩ	2
10 to 97.6 kΩ	3
100 to 976 kΩ	4
1 to 9.76 MΩ	5
10 ΜΩ	6

ORDERING EXAMPLE

The ordering code of a RC11 resistor, value 4700 Ω with $\pm 2\%$ tolerance, supplied on paper tape of 5000 units per reel is: 2322 730 31472.

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of $\pm 5\%$ or $\pm 2\%$. The values of the E24 series are in accordance with "IEC publication 60063".

Limiting values

TYPE	LIMITING VOLTAGE ⁽¹⁾ (V)	LIMITING POWER (W)
RC01	200	0.25
RC11	150	0.125
RC21	50	0.063
RC31	50	0.063

Note

1. This is the maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-8".

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1.

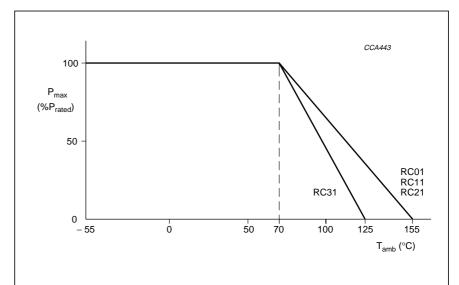


Fig.1 Maximum dissipation (P_{max}) in percentage of rated power as a function of the ambient temperature (T_{amb}).

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

PULSE LOADING CAPABILITIES

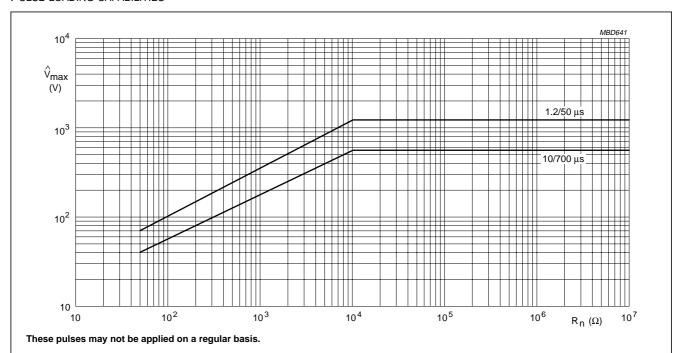
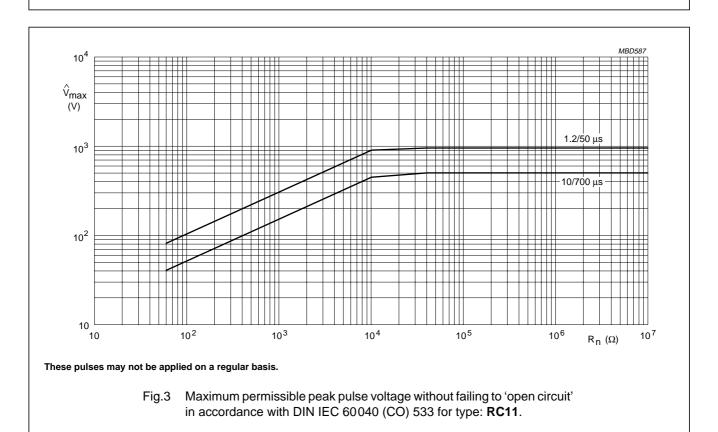
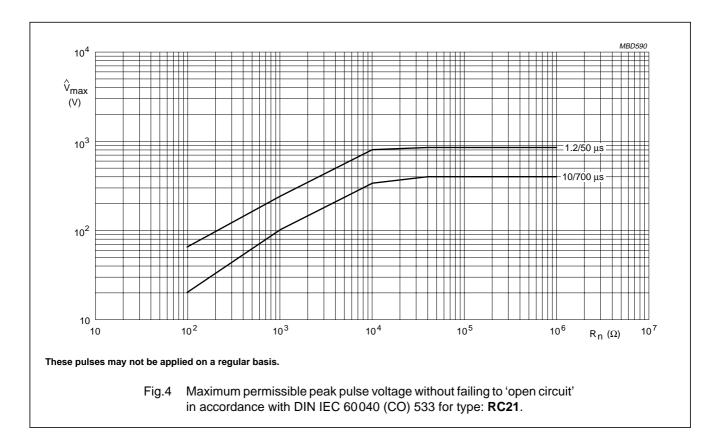


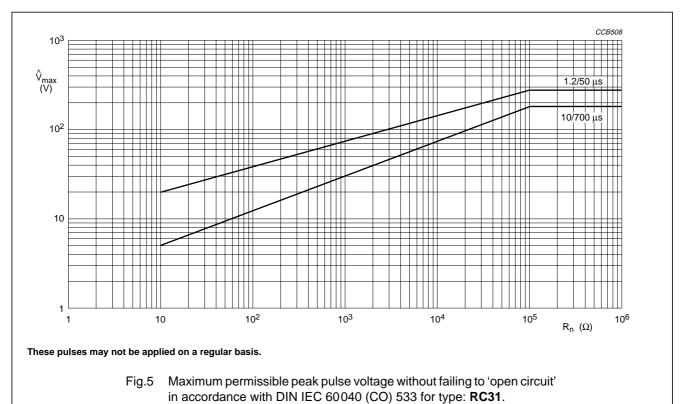
Fig.2 Maximum permissible peak pulse voltage without failing to 'open circuit' in accordance with DIN IEC 60040 (CO) 533 for type: **RC01**.



General purpose chip resistors sizes 1206, 0805, 0603 and 0402

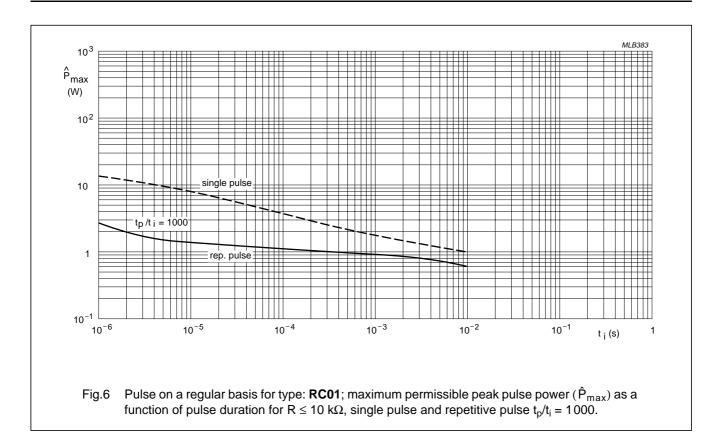
RC01/11/21/31 5%; 2%





General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%



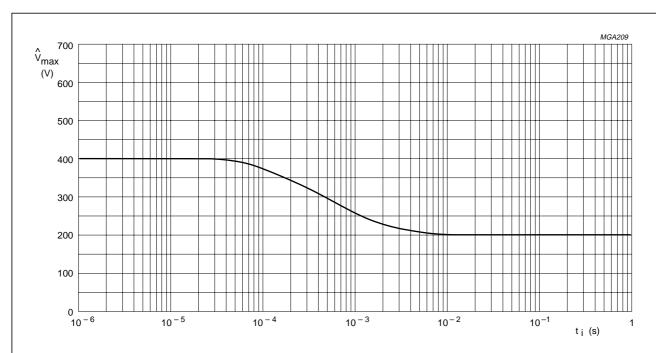
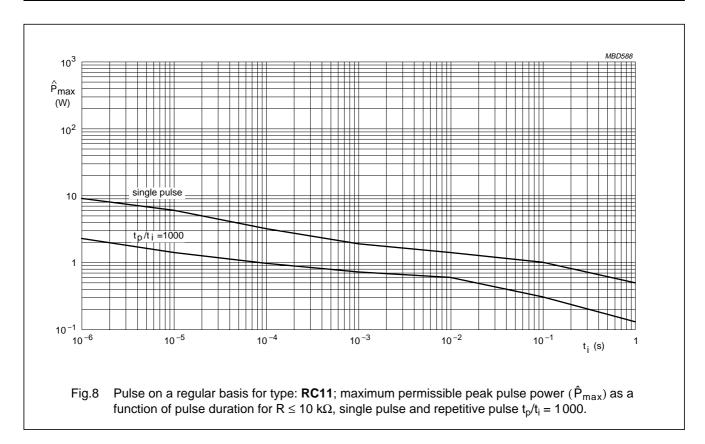
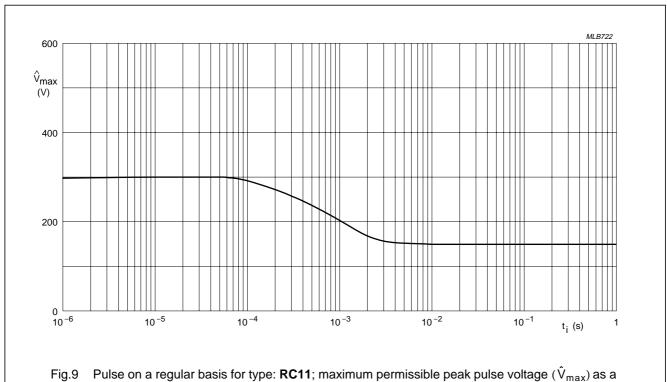


Fig.7 Pulse on a regular basis for type: **RC01**; maximum permissible peak pulse voltage (\hat{V}_{max}) as a function of pulse duration.

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%





1999 Feb 10 220

function of pulse duration.

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

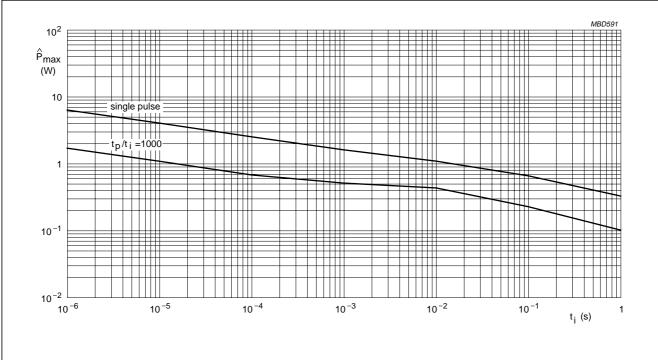


Fig.10 Pulse on a regular basis for type: **RC21**; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration for R ≤ 10 kΩ, single pulse and repetitive pulse $t_p/t_i = 1000$.

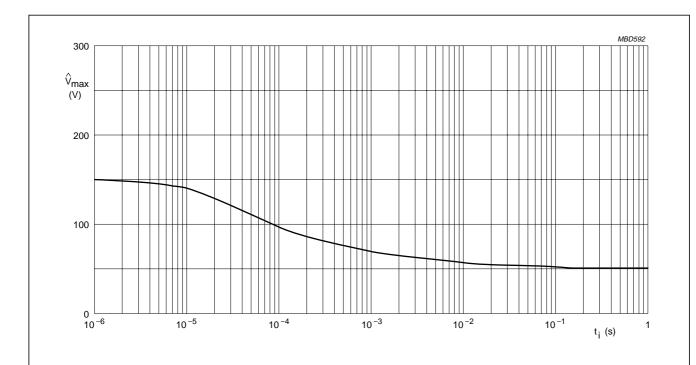


Fig.11 Pulse on a regular basis for type: **RC21**; maximum permissible peak pulse voltage (\hat{V}_{max}) as a function of pulse duration.

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

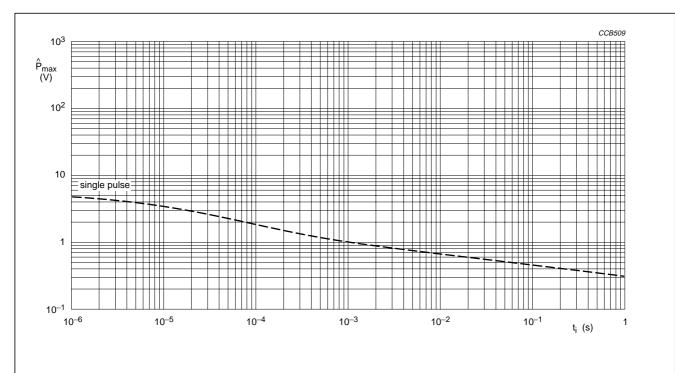


Fig.12 Pulse on a regular basis for type: **RC31**; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration for R \leq 10 k Ω , single pulse and repetitive pulse $t_0/t_i = 1000$.

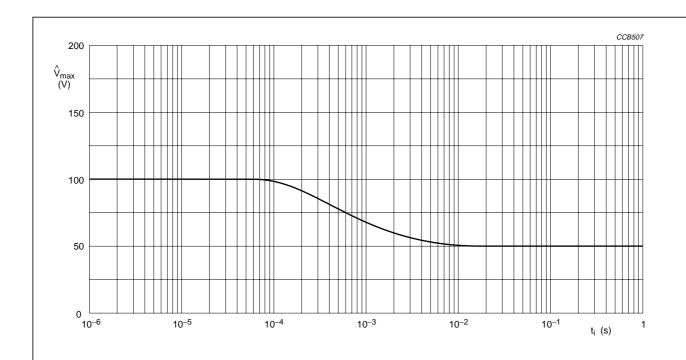


Fig.13 Pulse on a regular basis for type: **RC31**; maximum permissible peak pulse voltage (\hat{V}_{max}) as a function of pulse duration.

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

RC01/11/21/31 5%; 2%

MECHANICAL DATA

Mass per 100 units

TYPE	MASS (g)
RC01	1.0
RC11	0.55
RC21	0.25
RC31	0.052

Marking

Each resistor, except RC31, is marked with a three digit code (occasionally four digit) on the protective coating to designate the nominal resistance value.

3-DIGIT MARKING

For values up to 91 Ω the R is used as a decimal point. For values of 100 Ω or greater the first 2 digits are significant, the third indicates the number of zeros to follow.

Example

MARKING	RESISTANCE
12R	12 Ω
823	82 kΩ

4-DIGIT MARKING

For values up to 976 Ω the R is used as a decimal point. For values of 1 k Ω or greater the first 3 digits are significant, the fourth indicates the number of zeros to follow.

Example

MARKING	RESISTANCE
12R0	12 Ω
8202	82 kΩ

PACKAGE MARKING

The packaging is also marked and includes resistance value, tolerance, catalogue number, quantity, production period, batch number and source code.

Outlines

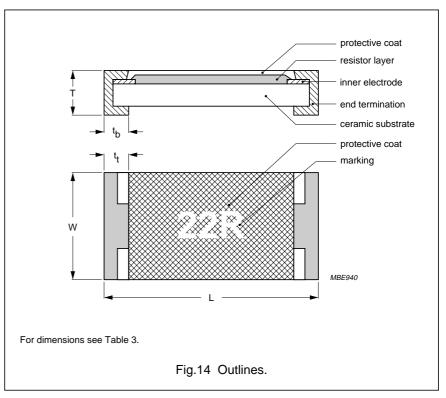


Table 3 Chip resistor types and relevant physical dimensions; see Fig.14

TYPE	L (mm)	W (mm)	T (mm)	t _t (mm)	t _b (mm)
RC01	3.20 +0.10/–0.20	1.60 ±0.15	0.55 ±0.10	0.45 ±0.25	0.50 ±0.25
RC11	2.00 ±0.15	1.25 ±0.15	0.55 ±0.10	0.40 ±0.20	0.40 ±0.20
RC21	1.60 ±0.10	0.80 +0.15/–0.05	0.45 ±0.10	0.30 ±0.20	0.30 ±0.20
RC31	1.00 ±0.05	0.50 ±0.05	0.35 ±0.05	0.20 ±0.10	0.25 ±0.10

sizes

1206,

, 0805,

0603 and 0402

General purpose

chip resistors

RC01/11/21/31

5%;

Essentially all tests are carried out in accordance with the schedule of "IEC publication 60115-8", category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, **56** days). The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068. "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to "IEC 60068-1", subclause 5.3.

Unless otherwise specified the following values apply:

Temperature: 15 °C to 35 °C Relative humidity: 45% to 75%

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar).

In Table 4 the tests and requirements are listed with reference to the relevant clauses of "IEC publications 60115-8 and 60068"; a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

Table 4 Test procedures and requirements

IEC	IEC			REQUIREMENTS				
60115-8 CLAUSE	60068-2 TEST METHOD	TEST	PROCEDURE	RC01	RC11	RC21	RC31	
Tests in a	accordance	with the schedule o	of IEC publication 60115-8					
4.4.1		visual examination			no holes; cle	ean surface;	no visible damage	
4.4.2		dimensions (see Fig.14)	gauge (mm)			see Tabl	e 3	
4.5		resistance	applied voltage (+0/-10%):	F	R – R _{nom} : ma	ax. ±2% or F	R - R _{nom} : max. ±5%	
			R < 10 Ω: 0.1 V					
			10 Ω ≤ R < 100 Ω: 0.3 V					
			100 Ω ≤ R < 1 kΩ: 1 V					
			1 kΩ ≤ R < 10 kΩ: 3 V					
			10 kΩ ≤ R < 100 kΩ: 10 V					
			100 kΩ ≤ R < 1 MΩ: 25 V					
			R ≥ 1 MΩ: 50 V					
4.18	20 (Tb)	resistance to	unmounted chips; 10 ±1 s; 260 ±5 °C	no	visible dam	age	no visible damage	
		soldering heat		$\Delta R/R$ m	ax.: ±(0.5%	+0.05 Ω)	Δ R/R max.: ±(1% +0.05 Ω)	
4.29	45 (Xa)	component solvent resistance	isopropyl alcohol or H ₂ O followed by brushing in accordance with "MIL 202 F"			no visible d	amage	

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

IEC	IEC			REQUIREMENTS				
60115-8 CLAUSE	60068-2 TEST METHOD	TEST	PROCEDURE	RC01	RC11	RC21	RC31	
4.17	20 (Ta)	solderability	unmounted chips completely immersed for 2 ±0.5 s in a solder bath at 235 ±2 °C	good tinning (≥95% covered); no visible damage				
4.7		voltage proof on insulation	maximum voltage (RMS) during 1 minute metal block method		no b	reakdown oi	r flashover	
4.13		short time overload	room temperature; $P = 6.25 \times P_n$; 5 s (V $\leq 2 \times V_{max}$)	ΔR/R m	nax.: ±(1% +	0.05 Ω)	ΔR/R max.: ±(2% +0.1 Ω)	
4.33		bending	resistors mounted on a 90 mm glass epoxy resin PCB (FR4), bending: 3 mm for RC01 and 5 mm for RC11 , RC21 and RC31	no visible damage; $\Delta R/R \; \text{max.:} \; \pm (1\% \; \text{+0.05} \; \Omega)$				
4.19	14 (Na)	rapid change of temperature	30 minutes at LCT and 30 minutes at UCT; 5 cycles	no visible damage; Δ R/R max.: \pm (0.5% +0.05 Ω)			no visible damage; Δ R/R max.: ±(2% +0.1 Ω)	
4.24.2	3 (Ca)	damp heat (steady state)	56 days; 40 ±2 °C; 93 +2/–3% RH; loaded with 0.01 P _n :	(,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		,		
			$R \le 1 MΩ$ R > 1 MΩ		nax.: ±(1.5% max.: ±(3% -	•	ΔR/R max.: ±(3% +0.1 Ω)	
4.25.1		endurance	1000 +48/ $-$ 0 hours; loaded with P_n or V_{max} ; 1.5 hours on and 0.5 hours off:	, , ,				
			$R \le 1 MΩ$ R > 1 MΩ	Δ R/R max.: \pm (1.5% +0.1 Ω) Δ R/R max.: \pm (3% +0.1 Ω)		•	ΔR/R max.: ±(3% +0.1 Ω)	
4.23.2	27 (Ba)	endurance at upper category temperature	1000 +48/–0 hours; no load: R \leq 1 MΩ	Δ R/R max.: ±(1.5% +0.1 Ω)		Δ R/R max.: $\pm(3\%$ +0.1 $\Omega)$		
4.8.4.2		temperature coefficient	R > 1 MΩ at 20/LCT/20 °C and 20/UCT/20 °C: $R \le 10 \ \Omega$	Δ R/R max.: ±(3% +0.1 Ω) – \leq 250 ±250 × 10 ⁻⁶ /K				
			10 Ω < R	≤±200 × 10 ⁻⁶ /K				

RC01/11/21/31 5%; 2%

General purpose chip resistors sizes 1206, 0805, 0603 and 0402

IEC	IEC			REQUIREMENTS					
60115-8 CLAUSE	60068-2 TEST METHOD	TEST	PROCEDURE	RC01	RC11	RC21	RC31		
Other tes	ts in accor	dance with IEC 6011	5 clauses and IEC 60068 test method						
4.17	20 (Ta)	solderability (after ageing)	95% covered	d); no visible damage					
4.6.1.1		insulation resistance	voltage (DC) after 1 minute, metal block method: 100 V for RC01 and RC11, 50 V for RC21 and RC31	R_{ins} min.: 10^3 $M\Omega$					
4.12		noise	IEC publication 60195 (measured with Quantech - equipment):						
			R ≤ 100 Ω	max. $0.316 \mu V/V (-10 dB)$					
			100 Ω < R ≤ 1 kΩ	max. 1 μV/V (0 dB)					
			1 kΩ < R ≤ 10 kΩ	max. 3 μV/V (9.54 dB)					
			10 kΩ < R ≤ 100 kΩ			max. 6 μV/V	(15.56 dB)		
			100 kΩ < R ≤ 1 MΩ		n	nax. 10 μV/V	(20 dB)		
			1 MΩ < R ≤ 10 MΩ	max. 32 μV/V (30.10 dB)					
Other app	plicable tes	ts							
	(JIS) C 5202 7.5	resistance to damp heat (steady state)	1000 +48/–0 hours; 40 ±2 °C; 93 +2/–3% RH; loaded with P _n or V _{max} ; 1.5 hours on and 0.5 hours off:	f:					
			R ≤ 1 MΩ		ΔR	'R max.: ±(39	% +0.1 Ω)		
			R > 1 MΩ		ΔR	'R max.: ±(5°	% +0.1 Ω)		
		leaching	unmounted chips; 60 ±1 s; 260 ±5 °C		god	od tinning; no	leaching		
		trio damp heat test	1 000 +48/–0 hours; 85 ±2 °C; 85 ±5% RH; loaded with 0.01 P _n or V _{max}						
			R ≤ 1 MΩ		ΔR	'R max.: ±(39	% +0.1 Ω)		
			R > 1 MΩ		ΔR /	'R max.: ±(59	% +0.1 Ω)		

RC01/11/21/31 5%; 2%